

## IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicants : Syuji Tsukamoto et al.  
Application No. : 10/691,851  
Filed : October 23, 2003  
For : METHOD FOR CUTTING A PHOTORESIST-COATED GLASS BOARD, CUTTING MACHINE FOR CUTTING A PHOTORESIST-COATED GLASS BOARD AND METHOD FOR MANUFACTURING AN OPTICAL RECORDING MEDIUM  
Examiner : Maria Alexandra Elve  
Art Unit : 1725  
Docket No. : 890050.442  
Date : March 28, 2007

Mail Stop AF  
Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT TRANSMITTAL

Commissioner for Patents:

In accordance with 37 CFR 1.56 and 1.97 through 1.98, applicants wish to make known to the U.S. Patent and Trademark Office the references set forth on the attached Supplemental Information Disclosure Statement. Copies of cited U.S. patents and published patent applications are not required and accordingly have not been provided. Copies of any other cited references are enclosed. As to any reference cited, applicants do not admit that it is "prior art" under 35 U.S.C. §§ 102 or 103, and specifically reserve the right to traverse or antedate any such reference, as by a showing under 37 CFR 1.131 or other method. Although the aforesaid references are made known to the Patent and Trademark Office in compliance with applicants' duty to disclose all information they are aware of which is believed relevant to the examination of the above-identified application, applicants believe that their invention is patentable.


I hereby certify that each item of information contained in the attached Information Disclosure Statement was first cited in any communication from a foreign patent office in a counterpart foreign application and that this communication was not received by any

individual designated in §1.56(d) more than thirty days prior to the filing of this Information Disclosure Statement.

Please acknowledge receipt of this Supplemental Information Disclosure Statement and kindly make the cited references of record in the above-identified application.

Applicants believe this Supplemental Information Disclosure Statement has been timely filed, however, the Director is authorized to charge any fee due by way of this Supplemental Information Disclosure Statement to our Deposit Account No. 19-1090.

Respectfully submitted,  
Seed Intellectual Property Law Group PLLC

  
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Enclosures:  
Supplemental Information Disclosure Statement  
Cited References (5)

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